

2SC5034

Silicon NPN triple diffusion planar type

For high breakdown voltage high-speed switching

Features

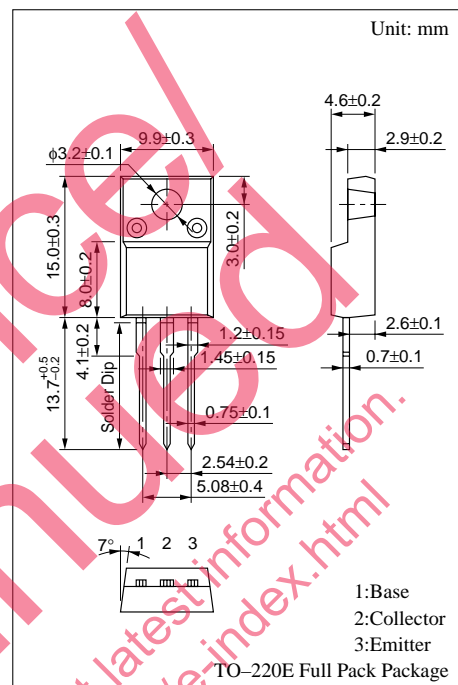
- High collector to emitter V_{CEO}
- High-speed switching
- Full-pack package with outstanding insulation, which can be installed to the heat sink with one screw

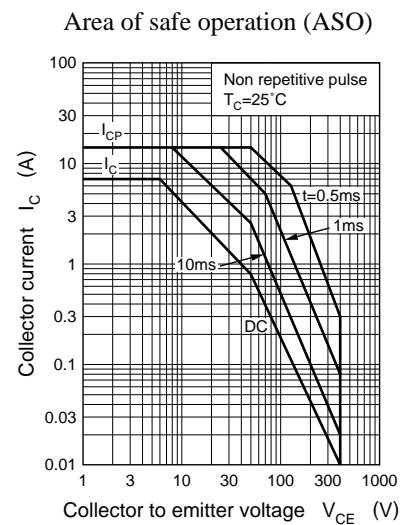
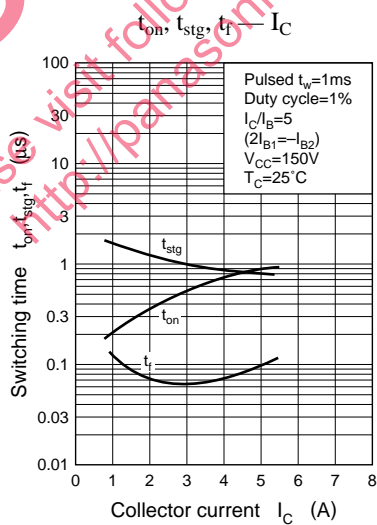
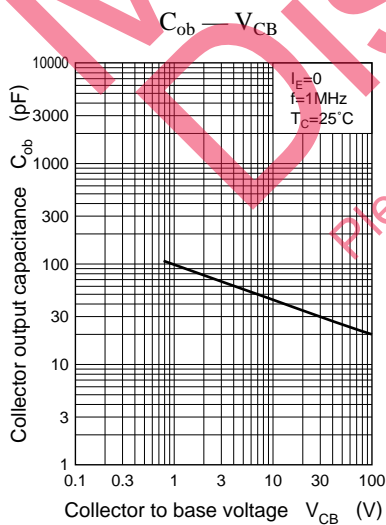
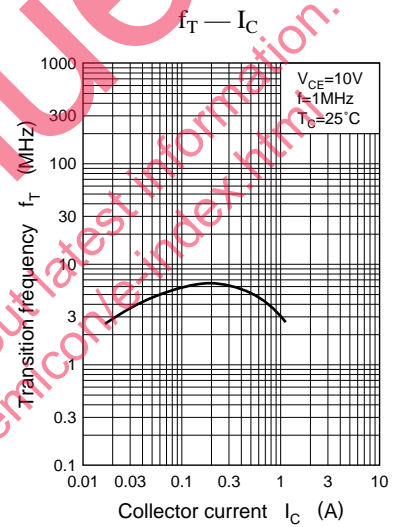
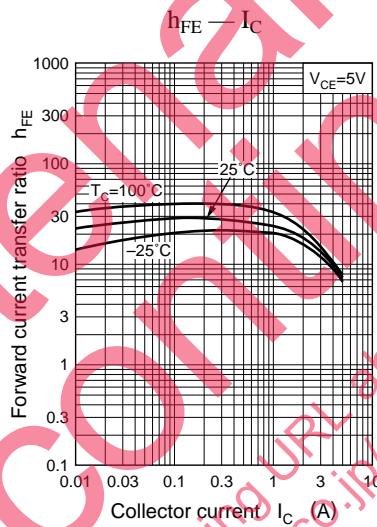
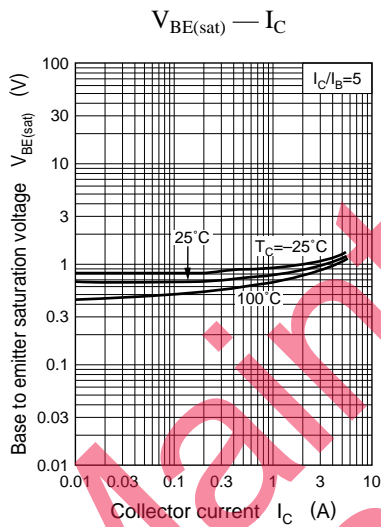
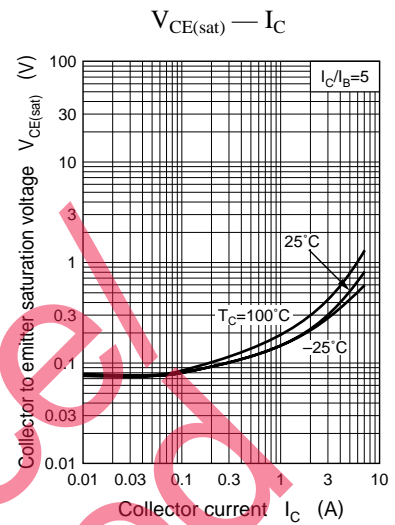
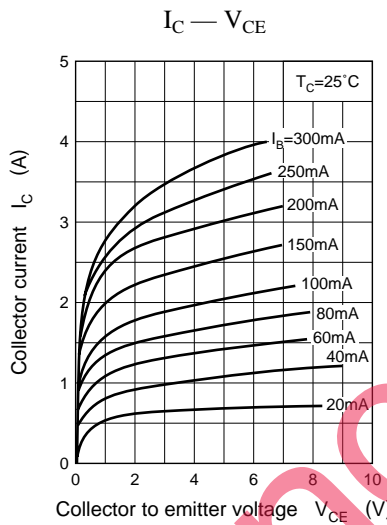
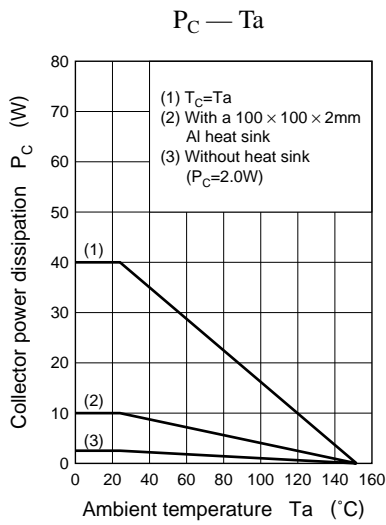
Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Rated	Unit	
Collector to base voltage	V_{CBO}	500	V	
Collector to emitter voltage	V_{CES}	500	V	
	V_{CEO}	400	V	
Emitter to base voltage	V_{EBO}	7	V	
Peak collector current	I_{CP}	15	A	
Collector current	I_C	7	A	
Base current	I_B	3	A	
Collector power dissipation	P_C	$T_C=25^\circ\text{C}$	35	W
		$T_a=25^\circ\text{C}$	2.0	
Junction temperature	T_j	150	$^\circ\text{C}$	
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$	

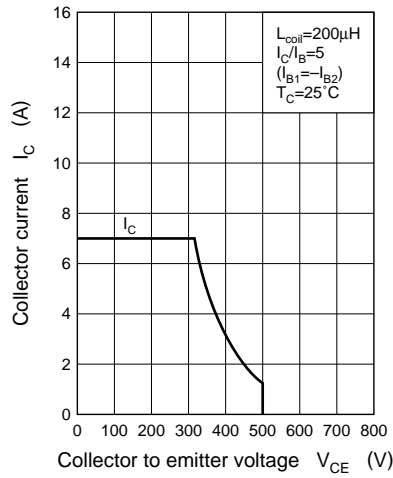
Electrical Characteristics ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 500\text{V}, I_E = 0$			100	μA
Emitter cutoff current	I_{EBO}	$V_{EB} = 5\text{V}, I_C = 0$			100	μA
Collector to emitter voltage	V_{CEO}	$I_C = 10\text{mA}, I_B = 0$	400			V
Forward current transfer ratio	h_{FE1}	$V_{CE} = 5\text{V}, I_C = 0.1\text{A}$	10			
	h_{FE2}	$V_{CE} = 5\text{V}, I_C = 3\text{A}$	8			
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 3\text{A}, I_B = 0.6\text{A}$			1.0	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 3\text{A}, I_B = 0.6\text{A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 10\text{V}, I_C = 0.5\text{A}, f = 1\text{MHz}$		10		MHz
Turn-on time	t_{on}	$I_C = 3\text{A}, I_{B1} = 0.6\text{A}, I_{B2} = -1.2\text{A}, V_{CC} = 150\text{V}$			1.0	μs
Storage time	t_{stg}				2.0	μs
Fall time	t_f				0.3	μs

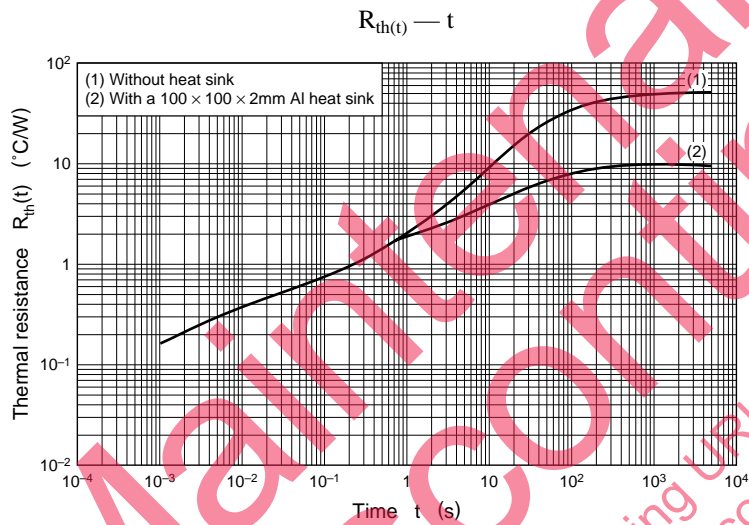
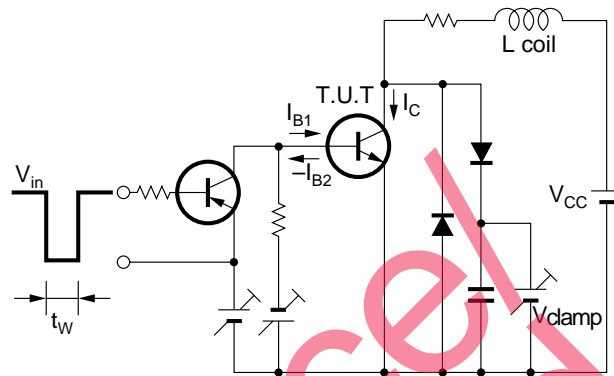




Area of safe operation, reverse bias ASO



Reverse bias ASO measuring circuit



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